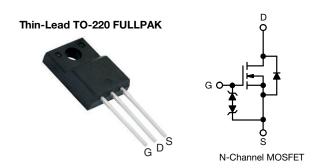
COMPLIANT

HALOGEN

**FREE** 



## **E Series Power MOSFET**



PRODUCT SUMMARY	Y	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	85	50
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.826
Q <sub>g</sub> max. (nC)	22	5
Q <sub>gs</sub> (nC) 4		1
Q <sub>gd</sub> (nC)	7	7
Configuration	Sin	gle

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA6N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (To	<sub>c</sub> = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	800	V	
Gate-source voltage		$V_{GS}$	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	,	5	
Continuous drain current (1j = 150 °C) °	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	3.2	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10	
Linear derating factor	inear derating factor			0.24	W/°C
Single pulse avalanche energy b		E <sub>AS</sub>	20.3	mJ	
Maximum power dissipation		$P_{D}$	30	W	
Operating junction and storage temperature range	,		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope T,		T <sub>J</sub> = 125 °C	dv/dt	100	V/ns
Reverse diode dv/dt d			αν/αι	0.4	V/IIS
Soldering recommendations (peak temperature) <sup>c</sup>		For 10 s		260	°C
Mounting torque, M3 screw				0.6	Nm

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature b.  $V_{DD}=140~V$ , starting  $T_J=25~^{\circ}C$ , L=28.2~mH,  $R_g=25~\Omega$ ,  $I_{AS}=1.2~A$  c. 1.6 mm from case

- c. 1.6 mm from case d.  $I_{SD} \le I_{D}$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C e. Limited by maximum junction temperature



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	=	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	4.2	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Cata assuma laglanda		,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 10	
Gate-source leakage	$I_{GSS}$	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 50	μA
Zoro goto voltago droip ourrent	1	V <sub>DS</sub> =	: 800 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 640 \text{ V}$	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2 A	-	0.826	0.950	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 3 A	-	1.9	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V, f = 1 MHz		422	-	pF
Output capacitance	C <sub>oss</sub>	Ţ ,			24	-	
Reverse transfer capacitance	C <sub>rss</sub>	7			4	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	V 0V4-400VV 0V		-	17	-	
Effective output capacitance, time related <sup>b</sup>	$C_{o(tr)}$	V <sub>DS</sub> = 0 V	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		92	-	
Total gate charge	Qg			-	15	22.5	
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$	$I_D = 3 A, V_{DS} = 640 V$	-	4	-	nC
Gate-drain charge	$Q_gd$			-	7	-	
Turn-on delay time	$t_{d(on)}$			-	12	24	
Rise time	t <sub>r</sub>	$V_{DD} = 640 \text{ V}, I_D = 3 \text{ A},$		-	10	20	ne
Turn-off delay time	$t_{d(off)}$	V <sub>GS</sub> =	= 10 V, $R_g = 9.1 \Omega$	-	16	32	ns
Fall time	t <sub>f</sub>			-	20	40	
Gate input resistance	$R_{g}$	f = 1	f = 1 MHz, open drain		2	4	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	5	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	10	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	285	570	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$ $di/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	1.7	3.4	μC
Reverse recovery current	I <sub>RRM</sub>			_	9.9	-	A

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

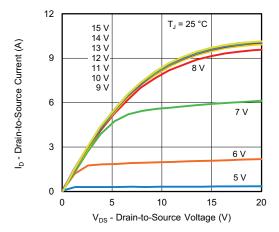


Fig. 1 - Typical Output Characteristics

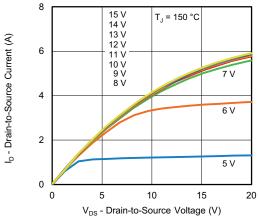


Fig. 2 - Typical Output Characteristics

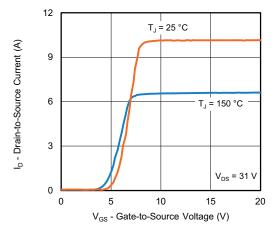


Fig. 3 - Typical Transfer Characteristics

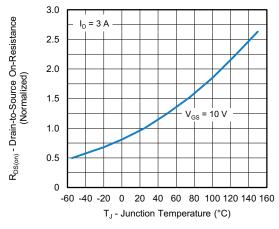


Fig. 4 - Normalized On-Resistance vs. Temperature

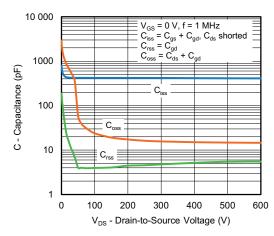


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

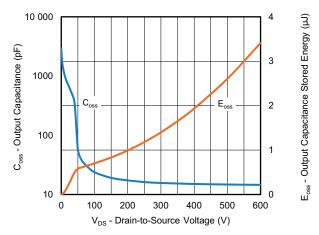


Fig. 6 - Coss and Eoss vs. VDS



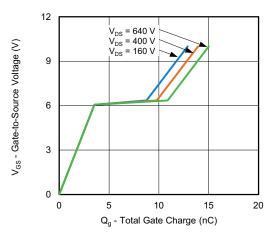


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

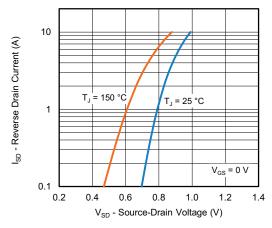


Fig. 8 - Typical Source-Drain Diode Forward Voltage

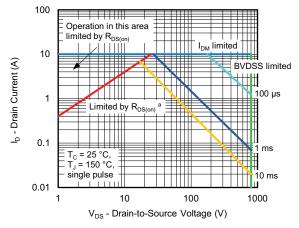


Fig. 9 - Maximum Safe Operating Area



a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

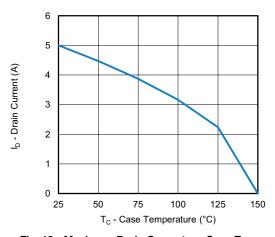


Fig. 10 - Maximum Drain Current vs. Case Temperature

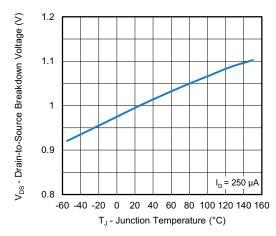


Fig. 11 - Temperature vs. Drain-to-Source Voltage



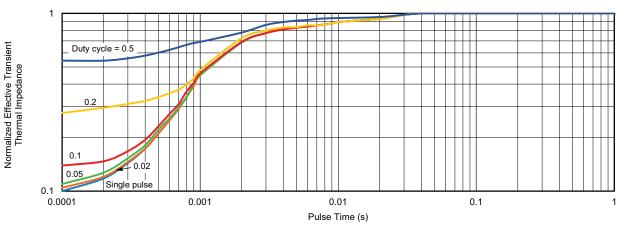


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

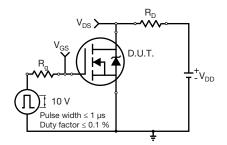


Fig. 13 - Switching Time Test Circuit

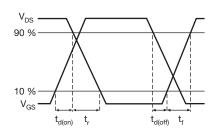


Fig. 14 - Switching Time Waveforms

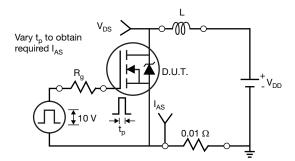


Fig. 15 - Unclamped Inductive Test Circuit

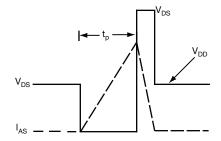


Fig. 16 - Unclamped Inductive Waveforms

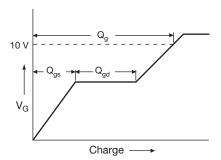


Fig. 17 - Basic Gate Charge Waveform

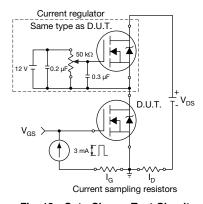


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dv/dt Test Circuit

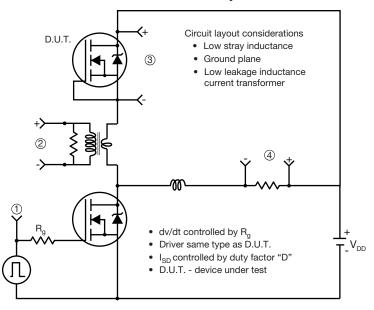




Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL		DIMEN	ISIONS	
	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
Е	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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